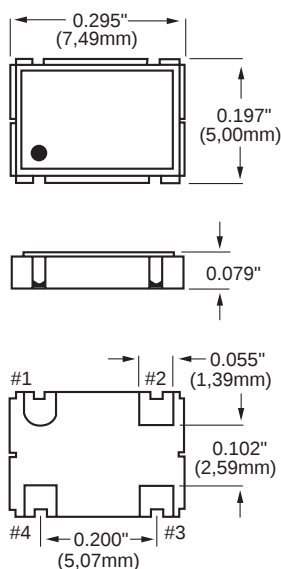


VF3

VF3 Series Miniature Ceramic SMD Tristate Oscillator 10LS–TTL Compatible

FEATURES

- Miniature Ceramic Package
- Wide Frequency Range
- Industrial Temperature Available



All dimensions are typical unless otherwise specified.

Creating a Part Number

VF3 [] [] - [] - **FREQ.**

FREQUENCY STABILITY	
Code	Specification
S	±20 ppm
A	±25 ppm
B	±50 ppm
	±100 ppm (std.)

OPERATIONAL TEMP. RANGE	
Code	Specification
1	0°C to +70°C
	-40°C to +85°C*

SYMMETRY	
Code	Specification
H	±5.0%
	±10.0%

Example: ?????

Parameter	Symb	Condition	Min	Typ	Max	Unit	Note
Input Break Down Voltage	V _{cc}		-0.5		7.0	V	
Storage Temp.	T _s		-55		+125	°C	
Frequency Range	F		1.8		106.25	MHz	
Frequency Stability	ΔF/F	Overall	-100		100	ppm	1
Input Voltage	V _{cc}		3.15	3.3	3.45	V	
Input Current	I _{cc}	15pF load		10 15 18 28		mA	to 25MHz to 50MHz to 67MHz to 106MHz
Load	10LS-TTL gates or 15pF						
Duty Cycle		@50%V _{cc}	45 40	50 50	55 60	%	to 50MHz
Rise/Fall Time	T _r /T _f	10% to 90%		5	10	ns	
Logic "1" Level	V _{oh}	Loaded, overall	.9V _{cc}			V	
Logic "0" Level	V _{ol}	Loaded, overall			.1V _{cc}	V	
Enable Input Disable Input	Input HIGH (>2.5V) or floating: ACTIVE Input LOW (<0.5V): INFINITE IMPEDANCE						
Start-up Time	T _s			3	10	ms	
Enable/ Disable Time					100	ns	
Operating Temperature Range	-10°C to +70°C (-40°C to +85°C available)						
Mechanical Shock	Per MIL-STD-202, Method 213, Cond. E						
Thermal Shock	Per MIL-STD-883, Method 1011, Cond. A						
Vibration	Per MIL-STD-883, Method 2007, Cond. A						
Soldering Conditions	260°C, for 10s, Max; 230°C, for 90s, Max.						
Hermetic Seal	Leak rate less than 5 x 10 ⁻⁸ atm.cc/s of helium						
Pin Out	Pin #1–Tristate Control Pin #2–Case, GND Pin #3–Output Pin #4–V _{cc}						

Notes:

1. ±50ppm, ±25ppm and ±20ppm stability available up to 50MHz for -10°C to 70°C operating temperature range.

All specifications are subject to change without notice.